AF 2000

Docket No. PADEMARY AMENDMENT TRANSMITTAL LETTER M4065.0226/P226 Application No. Filing Date Examiner **Art Unit** 09/484,437-Conf. #9698 January 18, 2000 J. M. Mitchell 2813 Applicant(s): Tongbi Jiang Invention: Die attach curing method for semiconductor device TO THE COMMISSIONER FOR PATENTS Fransmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below. **CLAIMS AS AMENDED** Claims **Highest** Number Remaining Number After Previously **Extra Claims** Amendment Paid Present Rate **Total Claims** 24 26 X Independent 2 X Claims Multiple Dependent Claims (check if applicable) Other fee (please specify): TOTAL ADDITIONAL FEE FOR THIS AMENDMENT: 0.00 x Large Entity **Small Entity** x No additional fee is required for this amendment. Please charge Deposit Account No. in the amount of \$ A duplicate copy of this sheet is enclosed. A check in the amount of \$ to cover the filing fee is enclosed. Payment by credit card. Form PTO-2038 is attached. X The Director is hereby authorized to charge and credit Deposit Account No. 04-1073 as described below. A duplicate copy of this sheet is enclosed. x Credit any overpayment. x Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17. March 14, 2005 Dated: Thomas J. D'Amico Attorney Reg. No.: 28,371 DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP 2101 L Street NW Washington, DC 20037-1526 (202) 828-2232



Docket No.: M4065.0226/P226

(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Tongbi Jiang

Application No.: 09/484,437

Confirmation No.: 9698

Filed: January 18, 2000

Art Unit: 2827

For: DIE ATTACH CURING METHOD FOR

**BGA PRODUCT** 

Examiner: J. M. Mitchell

## AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)

MS AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

## **INTRODUCTORY COMMENTS**

In response to the Office Action dated December 14, 2004 (Paper No. 1212), finally rejecting claims 1-9, 11, 12, 14-20, and 33-40, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.